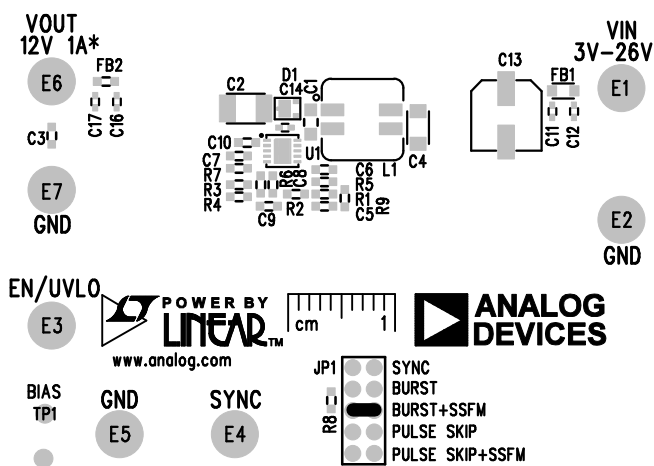


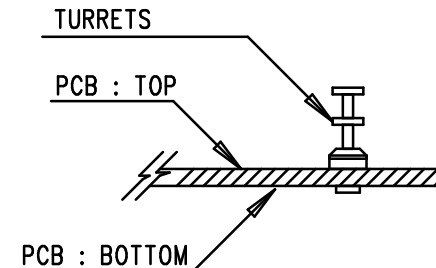
EVAL-LT8333-AZ
LOW I_Q 40V, 3A
BOOST/SEPIC/INVERTING CONVERTER

*SEE USER GUIDE
 FOR MAX IOUT VS VIN



NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
 MAXIMUM SOLDER TEMPERATURE IS 240 DEG C.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS.
 LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.
 MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE
 BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP
 TO ANY BOARD.



TITLE: TOP ASSEMBLY DRAWING
 LOW I_Q 40V, 3A
 BOOST/SEPIC/INVERTING CONVERTER

SIZE N/A	IC NO. LT8333RDD EVAL-LT8333-AZ	REV. 2
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FILENAME: EVAL-LT8333-AZ-2.PCB SHT 1 OF 1